

500.41374CX2

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): S. KANNO, et al
Serial No.: (not yet assigned)
Filed: September 10, 2003
For: WAFER STAGE FOR WAFER PROCESSING APPARATUS
AND WAFER PROCESSING METHOD

PRELIMINARY AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

September 10, 2003

Sir:

The following amendments and remarks are respectfully submitted in connection with the above-identified application, as listed below and as set forth on the following pages:

Amendment to the Title; and

Remarks are included following the amendments.

TITLE OF THE INVENTION:

Please change the title of the invention to:

WAFER PROCESSING METHOD